

Product / Process Change Notification



N° 2017-046-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an Additional Assembly and Test Location for TO220 Fullpak Narrow Lead products in Tianshui Huatian Microelectronics Co. LTD (TSHT), China for CoolMOS™ Products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **22. February 2018**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhober
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► **Products affected:**

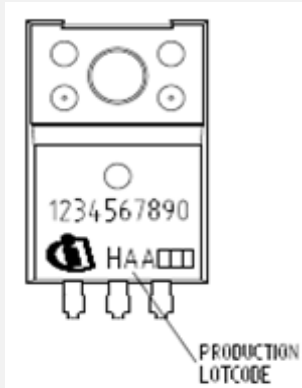
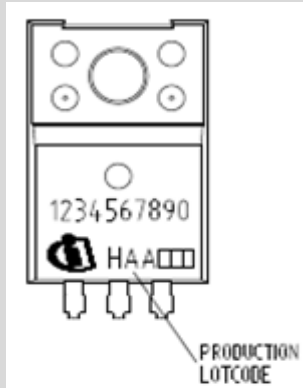
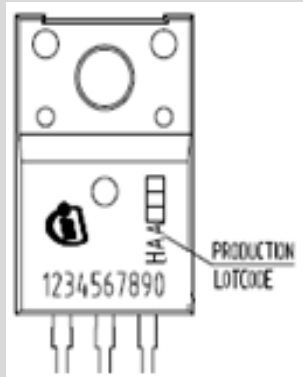
Sales Name	SP N°	OPN	Package
See affected product list (1_cip17046_a)			

► **Detailed Change Information:**

Subject: Introduction of an additional assembly and test location for TO220 Fullpak Narrow Lead products in Tianshui Huatian Microelectronics Co. LTD (TSHT), China for CoolMOS™ products

Reason: Capacity Extension for TO220 Fullpak Narrow Lead products

Description:

<u>Old</u>	<u>New</u>
<ul style="list-style-type: none"> Tongfu Microelectronic Co., Ltd. (TFME), China 	<ul style="list-style-type: none"> Tongfu Microelectronic Co., Ltd. (TFME), China Tianshui Huatian Microelectronics Co. LTD (TSHT), China
<ul style="list-style-type: none"> Package marking text placement for TFME 	<ul style="list-style-type: none"> Package marking text placement for TFME Package marking text placement for TSHT  

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▶ **Product Identification:**

Internal traceability: Baunumber, internal lot number and datecode
External traceability: Package marking

▶ **Impact of Change:**

- **NO** change on electrical, thermal parameters and reliability as proven via product qualification and characterization.
- **NO** change in package outline dimensions.
- **NO** change of existing Infineon specifications and datasheet parameters

▶ **Attachments:**

1_cip17046_a Affected Product List
2_cip17046_a Qualification Report

▶ **Time Schedule:**

- Final qualification report:
- First samples available:
- Intended start of delivery:

Available

Available on request

15-March-2018 or earlier pending on customer approval

If you have any questions, please do not hesitate to contact your local Sales office.